

What is claimed is:

Suba) 1. A connector for module that connects a module, which has a semiconductor chip mounted on a rectangular board and has a conductive pad on the front side of the board, to a printed circuit board in a position wherein the board plane is approximately parallel to the printed circuit board,

said connector for module, comprising:

a connector body having a receiving part that extends along the front side of the module being in the connection position and is provided in the rear face thereof with a groove into which the front side of the module is to be inserted, having a contact that is provided in the groove of the receiving part and contacts the conductive pad while allowing the pad to shift in the direction of insertion/withdrawal when the module is in the insertion/withdrawal position in which the rear side is at a higher level than in the connection position, and having a supporting part that extends rearward from the receiving part to support both the left and right sides and the bottom of the module being in the connection position; and

a metallic cover that is put over and is engaged to the connector body to sandwich the module between itself and the supporting part and keep the module in the connection position.

2. A connector for module according to claim 1 wherein

said metallic cover is hinged at the front to the receiving part and the rear end of the metallic cover can be lifted.

3. A connector for module according to claim 2 wherein

said metallic cover is removably provided to the connector body.

Sub a1) 4. A connector for module according to claim 2 wherein

said connector body or said metallic cover is provided with a positioning mechanism that positions the module in the front-rear direction when the module is set into the connection position.

5. A connector for module according to claim 4 wherein

said window is opened in said metallic cover to expose the semiconductor chip of the module being in the connection position, and in this window a heat sink that will contact said semiconductor chip is connected to the metallic cover.

6. A connector for module according to claim 5 wherein

at least one of said metallic cover and said heat sink covers a conductive member to exhibit the shielding function.

7. A connector for module according to claim 4 wherein

said metallic cover is provided with a contacting part that contacts the semiconductor chip of the module being in the connection position, and the contacting part is provided with a heat sink.

Sub a2) 8. A connector for module according to claim 7 wherein

at least one of said metallic cover and said heat sink covers a conductive member to exhibit the shielding function.

9. A connector for module according to claim 3 wherein

either said connector body or said metallic cover is provided with a positioning mechanism that position the module in the front-rear direction when the module is set in the connection position.

10. A connector for module according to claim 9 wherein

said window is opened in said metallic cover to expose the semiconductor chip of the module being in the connection position, and in this window a heat sink that will contact said semiconductor chip is connected to the metallic cover.

11. A connector for module according to claim 10 wherein

at least one of said metallic cover and said heat sink covers a conductive member to exhibit the shielding function.

12. A connector for module according to claim 9 wherein

said metallic cover is provided with a contacting part that contacts the semiconductor chip of the module being in the connection position, and the contacting part is provided with a heat sink.

13. A connector for module according to claim 12 wherein

at least one of said metallic cover and said heat sink covers a

09 conductive member to exhibit the shielding function.

14. A connector for module according to claim 1 wherein
said metallic cover is removably provided to the connector body.

Sebad 15. A connector for module according to claim 14 wherein
said connector body or said metallic cover is provided with a
positioning mechanism that positions the module in the front-rear direction
when the module is set into the connection position.

16. A connector for module according to claim 15 wherein
said window is opened in said metallic cover to expose the
semiconductor chip of the module being in the connection position, and in
this window a heat sink that will contact said semiconductor chip is
connected to the metallic cover.

17. A connector for module according to claim 16 wherein
at least one of said metallic cover and said heat sink covers a
conductive member to exhibit the shielding function.

18. A connector for module according to claim 15 wherein
said metallic cover is provided with a contacting part that contacts
semiconductor chip of the module being in the connection position, and the
contacting part is provided with a heat sink.

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NAME	ADDRESS	CITY	STATE	ZIP
Mr. J. H. Smith	123 Main St.	Springfield	Ill.	62761
Mr. R. L. Jones	456 Oak Ave.	Chicago	Ill.	60601
Mr. T. K. Brown	789 Elm St.	Peoria	Ill.	61601
Mr. S. M. White	101 Maple Dr.	Rockford	Ill.	61101
Mr. D. N. Black	202 Pine Ln.	Decatur	Ill.	62521
Mr. E. O. Green	303 Cedar St.	Normal	Ill.	62451
Mr. F. P. Hall	404 Birch Ave.	Urbana	Ill.	62501
Mr. G. Q. Adams	505 Walnut St.	Champaign	Ill.	61821
Mr. H. R. Baker	606 Spruce Dr.	Carbondale	Ill.	62901
Mr. I. S. Clark	707 Ash Ln.	Macomb	Ill.	61455
Mr. J. T. Evans	808 Hickory St.	Edwardsville	Ill.	62025
Mr. K. U. Foster	909 Sycamore Ave.	St. Louis	Mo.	63101
Mr. L. V. Gibson	1010 Poplar Dr.	St. Charles	Mo.	63301
Mr. M. W. Hardy	1111 Chestnut St.	St. Louis	Mo.	63101
Mr. N. X. Ingram	1212 Locust Ave.	St. Louis	Mo.	63101
Mr. O. Y. Keith	1313 Walnut Dr.	St. Louis	Mo.	63101
Mr. P. Z. Lane	1414 Elm St.	St. Louis	Mo.	63101
Mr. Q. A. Ross	1515 Oak Ave.	St. Louis	Mo.	63101
Mr. R. B. King	1616 Maple St.	St. Louis	Mo.	63101
Mr. S. C. Wright	1717 Pine Dr.	St. Louis	Mo.	63101
Mr. T. D. Scott	1818 Cedar Ln.	St. Louis	Mo.	63101
Mr. U. E. Green	1919 Birch St.	St. Louis	Mo.	63101
Mr. V. F. Adams	2020 Walnut Ave.	St. Louis	Mo.	63101
Mr. W. G. Baker	2121 Spruce Dr.	St. Louis	Mo.	63101
Mr. X. H. Clark	2222 Ash St.	St. Louis	Mo.	63101
Mr. Y. I. Evans	2323 Hickory Ave.	St. Louis	Mo.	63101
Mr. Z. J. Foster	2424 Sycamore Dr.	St. Louis	Mo.	63101
Mr. A. K. Gibson	2525 Poplar St.	St. Louis	Mo.	63101
Mr. B. L. Hardy	2626 Chestnut Ave.	St. Louis	Mo.	63101
Mr. C. M. Ingram	2727 Locust Dr.	St. Louis	Mo.	63101
Mr. D. N. Keith	2828 Walnut St.	St. Louis	Mo.	63101
Mr. E. O. Ross	2929 Elm Ave.	St. Louis	Mo.	63101
Mr. F. P. Adams	3030 Oak Dr.	St. Louis	Mo.	63101
Mr. G. Q. Baker	3131 Maple St.	St. Louis	Mo.	63101
Mr. H. R. Clark	3232 Pine Ave.	St. Louis	Mo.	63101
Mr. I. S. Evans	3333 Cedar Dr.	St. Louis	Mo.	63101
Mr. J. T. Foster	3434 Birch St.	St. Louis	Mo.	63101
Mr. K. U. Gibson	3535 Walnut Ave.	St. Louis	Mo.	63101
Mr. L. V. Hardy	3636 Spruce Dr.	St. Louis	Mo.	63101
Mr. M. W. Ingram	3737 Ash St.	St. Louis	Mo.	63101
Mr. N. X. Keith	3838 Hickory Ave.	St. Louis	Mo.	63101
Mr. O. Y. Foster	3939 Sycamore Dr.	St. Louis	Mo.	63101
Mr. P. Z. Gibson	4040 Poplar St.	St. Louis	Mo.	63101
Mr. Q. A. Hardy	4141 Chestnut Ave.	St. Louis	Mo.	63101
Mr. R. B. Ingram	4242 Locust Dr.	St. Louis	Mo.	63101
Mr. S. C. Keith	4343 Walnut St.	St. Louis	Mo.	63101
Mr. T. D. Ross	4444 Elm Ave.	St. Louis	Mo.	63101
Mr. U. E. Adams	4545 Oak Dr.	St. Louis	Mo.	63101
Mr. V. F. Baker	4646 Maple St.	St. Louis	Mo.	63101
Mr. W. G. Clark	4747 Pine Ave.	St. Louis	Mo.	63101
Mr. X. H. Evans	4848 Cedar Dr.	St. Louis	Mo.	63101
Mr. Y. I. Foster	4949 Birch St.	St. Louis	Mo.	63101
Mr. Z. J. Gibson	5050 Walnut Ave.	St. Louis	Mo.	63101